

Isc N-Channel MOSFET Transistor

TK25A10K3, ITK25A10K3

• FEATURES

- Low drain-source on-resistance:
 $R_{DS(ON)} = 31m\Omega$ (typ.)
- Enhancement mode:
 $V_{th} = 2.0$ to $4.0V$ ($V_{DS} = 10V, I_D = 1mA$)
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

• DESCRIPTION

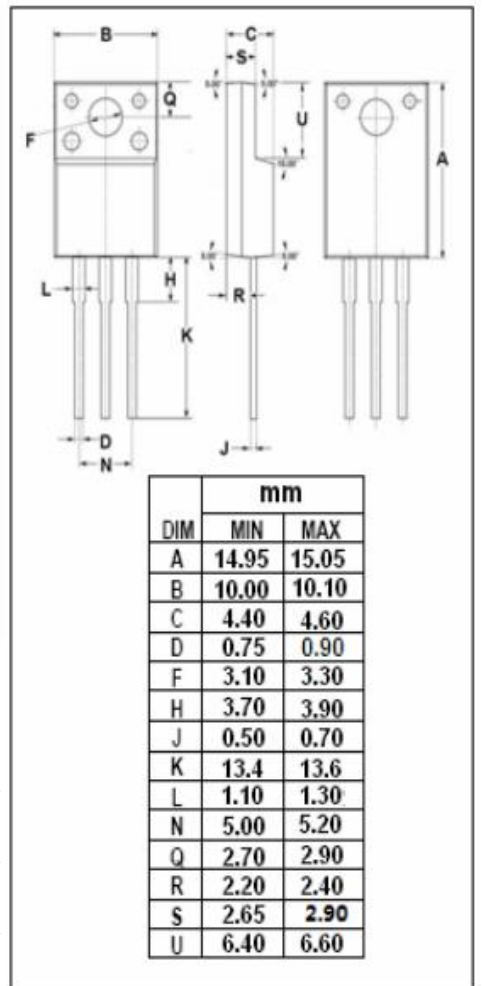
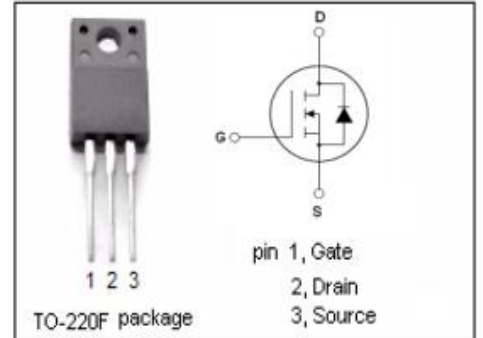
- Switching Voltage Regulators

• ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ C$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous	25	A
I_{DM}	Drain Current-Single Pulsed	50	A
P_D	Total Dissipation @ $T_c=25^\circ C$	25	W
T_j	Max. Operating Junction Temperature	150	$^\circ C$
T_{stg}	Storage Temperature	-55~150	$^\circ C$

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th(ch-c)}$	Channel-to-case thermal resistance	5.0	$^\circ C/W$
$R_{th(ch-a)}$	Channel-to-ambient thermal resistance	62.5	$^\circ C/W$



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ELECTRICAL CHARACTERISTICS

T_C=25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V; I _D = 10mA	100			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = 10V; I _D =1mA	2.0		4.0	V
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} =10V; I _D =12A		31	40	mΩ
I _{GSS}	Gate-Source Leakage Current	V _{GS} = ±20V; V _{DS} = 0V			± 100	μ A
I _{DSS}	Drain-Source Leakage Current	V _{DS} = 100V; V _{GS} = 0V			10	μ A
V _{SDF}	Diode forward voltage	I _{DR} =25A, V _{GS} = 0 V			1.4	V